Inline

FDAZ 350L, 650L, 800L

In-Line Series Specifications	PowerSpector FDAz 350L	PowerSpector FDAz 650L	PowerSpector FDAz 800L			
Maximum PCB Size	350x250mm (13.8"x9.8")	650x550mm (25.6"x21.6")	800x550mm (31.5"x21.6			
Characteristics						
Product type	Automatic Optical Inspector					
In-line/Off-line	In-Line					
Camera movement	X + Y Direction					
PCB movement	Stationary during inspection					
Parts inspection	Presence, Polarity, Offset, Correctness, Soldering					
Printing/paste inspection	Offset, Smearing, Bridges, Uniformity					
Distinction principle	Synthetic Imaging, Spectral Analysis, Greyscale limits					
Distinction parameters	Brightness, Hue, Saturation via Filters					
Camera type	Digital with CameraLink					
Camera Field Of View/Resolution	36x20mm/18.75µm or 19.2x10.8mm/10µ					
Lens	Telecentric lens with built in prism for DOAL Lighting					
	Omnidirectional Triple LED rings: Side, Main, Line Sourced DOAL (Diffused On					
Lighting system	Axis Lighting (Coaxial))					
Specifications						
Minimum inspection component size	01005" (0.4x0.2mm) (10µm resolution)					
Positioning accuracy	Pixel related Feedback Loop					
Component clearance (top)	+30mm (1.2")					
Side Cameras	8x Digital with CameraLink in 45/45 orientation					
Z-Axis movement range	30mm (1.2")					
Component clearance (bottom)	-35mm (-1.38") or -55mm (-21.7") without PCB support lift option					
Maximum PCB Size	350x250mm (13.8" x 9.8") 650x550mm (25.6" x 21.6") 800x550mm (31.5"x21.					
Movement speed	720mm/s					
Inspection capacity typical	1500cps/min					
Mains	100-240 Vac / 330W					
Conveyer						
Conveyer belt speed	10-500mm/s (0.4-19.7"/s)					
Conveyer configuration	Left>Right, Front rail fixed, Height 830-950mm					
PCB Clamping	Ruler Blade, Top & Edge Clamping, Sensor Stopper					
Minimum board size	50x50mm (0.2" x 0.2")					
Board thickness	0.6-2mm (option 0.6-4mm) (24mils - 79mils)					
PCB warpage compensation	Automatic PCB support Lift with magnetic pins (option)					
Interfacing						
Control PC type	Apple MacPro Intel with Mac OSX (not included)					
Control interface	USB / SMEMA (conveyer)					
Data interface	CameraLink					
General						
Operating temperature	15-30 degr C					
Operating humidity	15-80 % RH					
Follows at since	W740 x D786 x H1236	W1040 x D1077 x H1270	W1190 x D1077 x H1259			
External size Weight	(29.1" x 30.9" x 48.7") 180kg (397lbs)	(40.9" x 42.4" x 50.0") 240kg (529lbs)	(46.9" x 42.4" x 49.5") 290kg (639lbs)			
meigin	100kg (37/103)	240Kg (327103)	270KY (037103)			



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Contributing to your global success



in-Line and Desktop Automatic Optical Inspection systems

Automatic Optical Inspection of PCB assemblies

Inspect

Components: SMT & THT (missing, type, polarity, offset, text, colours etc)

Solder Paste and CIP (Components in Paste; prereflow)

Soldering: Post Reflow, Post Wave, Selective, Manual

Flexible classification and reporting scenarios

In Medium and XXL size PCB's versions

Multi-colour 3 angle lighting with Line Source Coaxial Lighting and Meniscus Profiler

Line Sourced DOAL coaxial lighting system with high resolution Telecentric Optics

Low Noise Large CCD High Speed 24 bit Colour Camera

Synthetic Imaging and Spectral Analysis

Triple use of side camera's (FDA and FDAz models only)

Prototype mode for 1st off inspection

In height adjustable optical head (FDLz and FDAz models only)

Compact footprint design

test your PCB's optically and replace manual inspection

use inspection in all stages of the production process

integrate AOI efficiently in your existing operations and factory lay-out

choose the best hardware configuration for your processes

reliable solder joint meniscus and pad surface analysis (to find meniscus and paste printing defects)

inspect solder joints without shadow effects from tall components nearby and accurate inspection model building

find defects easier including printing defects on Gold or Cu plated PCB's

powerful algorithms to achieve an optimal balance between defect detection and false reject levels in shortest time

Use for automatic inspection, classification and repair

program in minutes to verify your production line is set -up correctly before starting full production

Compensate for PCB warp and adapt to tall component and sandwich asseblies

maximize factory floor efficiency





Hardware and Software Features

High grade Telecentric Lens

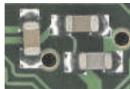
Parallel image over the whole sensor/lens Field of View - No parallax effect





Large pixel image capturing sensor

 $18,8\mu^2$ pixel size — less noise — smooth and detailed image— great dynamic range

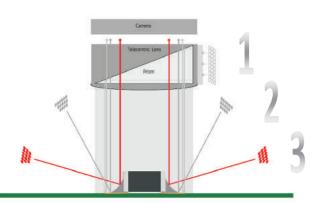




High dynamics sensor

Conventional sensor

Omnidirectional multi angle, multi color LED lighting
Optimal light no matter component direction — 3D color profile of solder meniscus — Reliable defect decision by the software — Decide Good Solder, No Solder, Lack of Solder and Too much solder for SMT and THT solder joints





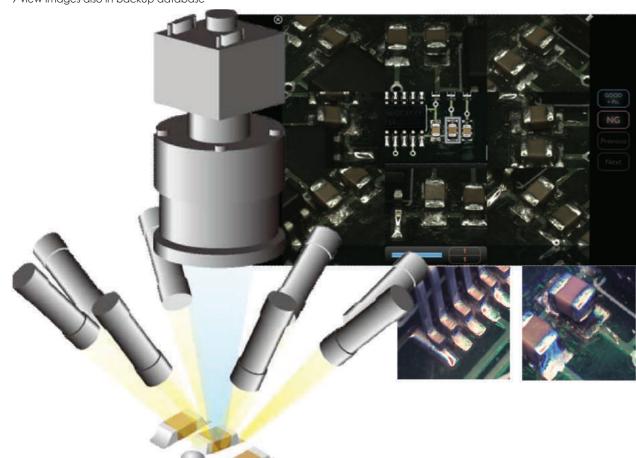






8x Angular Side Sensors with Tilt-Shift Lenses (Only available for FDA and FDAz models)

Simultaneously operating, multiplexed side view sensors with CameraLink interface — Shift & Tilt lenses for distortion free side images across whole FoV — 45/45 arrangement — Triple use: Active automatic inspection, classification and repair — clear 9 angles defect review — high magnification 50x (10µm/pixel) — Full Color — Auto highlight — Large sensor pixels — 9 view images also in backup database



Pawerspectar

Desktop

350, 460,650, 800

Desktop Series Specifications	PowerSpector FDAz 350	PowerSpector FD Az 460	PowerSpector FD Az 650	PowerSpector FD Az 800		
Maximum PCB Size	350x250mm (13.8" x 9.8")	460x350mm (18.1" x 13.8")	650x550mm (25.6" x 21.6")	800x550mm (31.5"x21.6")		
Characteristics						
Product type	Automatic Optical Inspector					
In-line/Off-line	Off-line Off-line					
Camera movement	X Direction	X + Y Direction	X + Y Direction	X + Y Direction		
PCB movement	Moving in Y	Stationary	Stationary	Stationary		
PCB fixation	Direct Loading	Direct Loading	Manual Drawer Options: Motorised Drawer, Transverse loader	Manual Drawer Options: Motorised Drawer, Transverse Ioader		
Parts inspection	Presence, Polarity, Offset, Correctness, Soldering					
Printing/paste inspection	Offset, Smearing, Bridges, Uniformity					
Distinction principle	Synthetic Imaging, Spectral Analysis, Greyscale limits					
Distinction parameters	Brightness, Hue, Saturation via Filters					
Camera type	Digital with CameraLink					
Camera Field Of View/Resolution		36x20mm/18.75µm or 19.2x10.8mm/10µ				
Lens	Telecentric lens with built in prism for DOAL Lighting					
Lighting system	Omnidirectional Triple LED rings: Side, Main, Line Sourced DOAL Diffused On Axis Lighting (Coaxial))					
Specifications						
Minimum inspection component size	01005" (0.4x0.2mm) (10µm resolution)					
Positioning accuracy	Pixel related Feedback Loop					
Component clearance (top)	+30mm (1.2")					
Side Cameras	8x Digital with CameraLink in 45/45 orientation					
Z-Axis movement range	60mm (2.4")					
Component clearance (bottom)	- 70mm (-2.8")	- 70mm (-2.8")	- 70mm (-2.8'')	- 70mm (-2.8")		
Maximum PCB Size	350x250mm (13.8" x 9.8")	460x350mm (18.1" x 13.8")	650x550mm (25.6" x 21.6")	800x550mm (31.5"x21.6")		
Movement speed	720mm/s					
Inspection capacity typical	1500cps/min					
Mains	100-240 Vac / 150W					
Interfacing						
Control PC type	Apple MacPro Intel QuadCore with Mac OSX (not included)					
Control interface	USB					
Data interface	CameraLink					
General						
Operating temperature	15-30 degr C					
Operating humidity	15-80 % RH					
External size	W736 x D874 x H450 (29.0" x 34.4" x 7.7")	W946 x D876 x H458 (37.2" x 34.5" x 18.0")	W940 x D1015 x H500 (37.0" x 34.0" x 19.7")	W1157 x D1015 x H50 (45.55" x 34.0" x 19.7"		
Weight	65kg (143lbs)	89kg (196lbs)	110kg (243lbs)	120kg (265lbs)		